Combined Declaration for Patent Application and Power of Attorney

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; and that I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF	AND APPARATUS	FOR FORM	ING THIN	METAL F	ILM /	
the specification of whi						
į į w	attached hereto; as filed in the United State S. Appln. No.		§111 on	:	, as	
[X] wo	as/will be filed in the U.S CT) application, Po *; nati	. under 35 U.S.C. CT/ <u>JP00/084</u> 18 onal stage applica	8 filed Novemb	er 29, 20	00 entry	requested or
da	te*	(* if known)				
and was amended on	include dates of amendments			if applicable).		
amendment referred to	nderstand the contents of above; and I acknowledge rial to patentability as def	the duty to disclos	se to the Patent			
or inventor's certificate, the "Yes" box checked,	riority benefits under 35 or §365(a) of any prior F and have also identified b ational application having	CT application(s) elow, by checking	designating a cotthe "No" box, as	ountry other thany foreign appli	in the U.S., cation for p	listed below with atent or inventor's
10-34022 (Number) 2000-303 (Number)	0 Japan (Country) 816 Japan (Country)	/ 03	/11/1999 (Day Month Year I /10/2000 (Day Month Year I	Filed)	YES N	lo lo l
I hereby claim the benefit	t under 35 U.S.C. §119(e)	of any United Sta	tes provisional a	applications list	ed below:	
	(Application N	0.)	(Day Month Y	ear Filed)		
	(Application N	0.)	(Day Month Y	ear Filed)		
PCT international application is not disclosuU.S.C. §112, I acknowle	it under 35 U.S.C. §120 ation(s) designating the Used in such U.S. or PCT dge the duty to disclose tame available between the tion:	.S., listed below ar international appli o the PTO all info	nd, insofar as the cation in the ma ormation which	e subject matter anner provided is material to p	r of each of by the first atentability	the claims of this paragraph of 35 as defined in 37
(Application)	No.) (Da	y Month Year Filed)	(S	status: patented, p	ending, aband	oned)
(Application I	Vo.) (Da	y Month Year Filed)	(S	tatus: patented, p	ending, aband	oned)
	hereby appoint the follow I Trademark Office conne		ctitioners to pro	osecute this ap	plication an	d to transact all
	All of the practition	ers associated with	hCustomer Nu	mber 001444)	
Direct all correspondence	to the address associated	with Customer Ni	umber 00 <u>1444</u>	which is preser	ntly:	
	B	ROWDY AND NE	EIMARK, P.L.L	С.		

The undersigned hereby authorizes the U.S. Attorneys or Agents appointed herein to accept and follow instructions from WATANABE & HOTTA as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. Attorneys or Agents and the undersigned. In the event of a change of the persons from whom instructions may be taken, the U.S. Attorneys or Agents appointed herein will be so notified by the undersigned.

624 Ninth Street, N.W. Washington, D.C. 20001-5303

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Page 2 of 2 Pages	Atty. Docket:
Title: METHOD OF AND APPARATUS FOR FORMING THIN METAL FILM	
J.S. Application filed, Serial No	
PCT Application filed November 29, 2000 Serial No. PCT / IPO0 / 084 18	

I hereby further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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